DATA SHEET

74ABT16245B 74ABTH16245B

16-bit bus transceiver (3-state)

Product specification
Supersedes data of 1996 Nov 20
IC23 Data Handbook

1998 Feb 25







Philips Semiconductors Product specification

16-bit bus transceiver (3-State)

74ABT16245B 74ABTH16245B

FEATURES

- 16-bit bidirectional bus interface
- Power-up 3-State
- Multiple V_{CC} and GND pins minimize switching noise
- 3-State buffers
- Output capability: +64 mA/-32mA
- Latch-up protection exceeds 500mA per JEDEC Std 17
- Live insertion/extraction permitted
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200V per Machine Model
- 74ABTH16245B incorporates bus hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs

DESCRIPTION

The 74ABT16245B high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT16245B device is a dual octal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. The control function implementation minimizes external timing requirements. The device features two Output Enable (1ŌE, 2ŌE) inputs for easy cascading and two Direction (1DIR, 2DIR) inputs for direction control.

Two options are available, 74ABT16245B which does not have the bus hold feature and the 74ABTH16245B which incorporates the bus hold feature.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	$C_L = 50pF; V_{CC} = 5V$	2.0 2.3	ns
C _{IN}	Input capacitance	$V_I = 0V \text{ or } V_{CC}$	4	pF
C _{I/O}	I/O pin capacitance	V _O = 0V or V _{CC} ; 3-State	7	pF
I _{CCZ}	Quiescent supply current	Outputs disabled; V _{CC} =5.5V	500	μΑ
Iccl	Quicocciti supply culterit	Output Low; V _{CC} =5.5V	10	mA

ORDERING INFORMATION

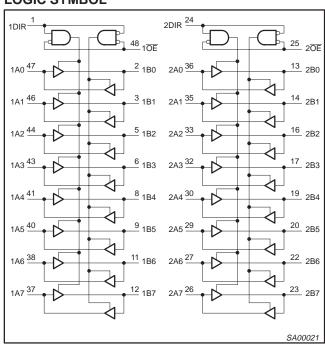
PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
48-Pin Plastic SSOP Type III	-40°C to +85°C	74ABT16245B DL	BT16245B DL	SOT370-1
48-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABT16245B DGG	BT16245B DGG	SOT362-1
48-Pin Plastic SSOP Type III	-40°C to +85°C	74ABTH16245B DL	BH16245B DL	SOT370-1
48-Pin Plastic TSSOP Type II	-40°C to +85°C	74ABTH16245B DGG	BH16245B DGG	SOT362-1

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PIN CONFIGURATION

f		
1DIR	1	48 1OE
1B0	2	47 1A0
1B1	3	46 1A1
GND	4	45 GND
1B2	5	44 1A2
1B3	6	43 1A3
Vcc	7	42 VCC
1B4	8	41 1A4
1B5	9	40 1A5
GND	10	39 GND
1B6	11	38 1A6
1B7	12	37 1A7
2B0	13	36 2A0
2B1	14	35 2A1
GND	15	34 GND
2B2	16	33 2A2
2B3	17	32 2A3
Vcc	18	31 VCC
2B4	19	30 2A4
2B5	20	29 2A5
GND	21	28 GND
2B6	22	27 2A6
2B7	23	26 2A7
2DIR	24	25 2 0E
		SA00020

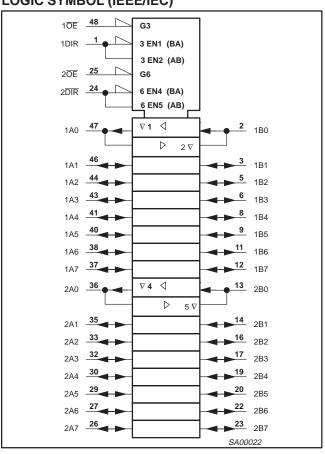
LOGIC SYMBOL



PIN DESCRIPTION

SYMBOL	PIN NUMBER	NAME AND FUNCTION
1DIR, 2DIR	1, 24	Direction control inputs (Active-High)
1A0 – 1A7, 2A0 – 2A7	47, 46, 44, 43 41, 40, 38, 37 36, 35, 33, 32 30, 29, 27, 26	Data inputs/outputs (A side)
1B0 – 1B7 2B0 – 2B7	2, 3, 5, 6 8, 9, 11, 12 13, 14, 16, 17 19, 20, 22, 23	Data inputs/outputs (B side)
1 OE , 2 OE	48, 25	Output enables
GND	4, 10, 15, 21 28, 34, 39, 45	Ground (0V)
V _{CC}	7, 18, 31, 42	Positive supply voltage

LOGIC SYMBOL (IEEE/IEC)



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FUNCTION TABLE

INP	JTS	INPUTS/C	UTPUTS
nOE	nDIR	nAx	nBx
L	L	A = B	Inputs
L	Н	Inputs	B = A
Н	Х	Z	Z

H = High voltage level

L = Low voltage level

X = Don't care

Z = High impedance "off" scale

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT	
V _{CC}	DC supply voltage		−0.5 to +7.0	V	
I _{IK}	DC input diode current	V _I < 0	-18	mA	
VI	DC input voltage ³		-1.2 to +7.0	V	
lok	DC output diode current	V _O < 0	-50	mA	
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V	
	DC sustaint surrout	output in Low state	128	A	
lout	DC output current	output in High state	-64	mA	
T _{stg}	Storage temperature range		-65 to 150	°C	

NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction
- temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMPOL	V _I Input voltage V _{IH} High-level input voltage V _{IL} Low-level Input voltage	LIM	UNIT	
STWIBOL	FARAMETER	Min	Max	ONIT
V _{CC}	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{OH}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
Δt/Δν	Input transition rise or fall rate	0	10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

						LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS		Ta	_{mb} = +25	s∘ C	T _{amb} =	: –40°C 85°C	UNIT
			Min	Тур	Max	Min	Min Max]	
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$		-0.9	-1.2		-1.2	V	
		$V_{CC} = 4.5V; I_{OH} = -3mA; V_{I} = V_{IL}$	or V _{IH}	2.5	2.9		2.5		V
V_{OH}	High-level output voltage	$V_{CC} = 5.0V; I_{OH} = -3mA; V_I = V_{IL}$	or V _{IH}	3.0	3.4		3.0		V
		$V_{CC} = 4.5V; I_{OH} = -32mA; V_{I} = V$	_{IL} or V _{IH}	2.0	2.4		2.0		V
V _{OL}	Low-level output voltage	$V_{CC} = 4.5V; I_{OL} = 64mA; V_{I} = V_{IL}$	or V _{IH}		0.42	0.55		0.55	V
I _I	Input leakage current	$V_{CC} = 5.5V; V_I = GND \text{ or } 5.5V$	Control pins		±0.01	±1.0		±1.0	μΑ
	Bus hold current	$V_{CC} = 4.5V; V_I = 0.8V$		50			50		
I_{HOLD}	A and B inputs 74ABTH16245B	$V_{CC} = 5.5V; V_I = 2.0V$	-75			-75		μА	
	74AB11110243B	$V_{CC} = 5.5V$; $V_I = 0$ to 5.5V	±500						
I _{OFF}	Power-off leakage current	$V_{CC} = 0.0V$; V_O or $V_I \le 4.5V$			±5.0	±100		±100	μΑ
I_{PU}/I_{PD}	Power-up/down 3-State output current	V_{CC} = 2.0V; V_{O} = 0.5V; V_{I} = GNE V_{OE} = Don't care	or V _{CC;}		±5.0	±50		±50	μА
I _{IH} +I _{OZH}	3-State output High current	$V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = V_{IL} C$	or V _{IH}		0.1	10		10	μΑ
I _{IL} +I _{OZL}	3-State output Low current	$V_{CC} = 5.5V; V_{O} = 0.0V; V_{I} = V_{IL} C$	or V _{IH}		0.1	10		10	μА
I _{CEX}	Output high leakage current	$V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = GNE$	or V _{CC}		5.0	50		50	μА
IO	Output current ¹	$V_{CC} = 5.5V; V_{O} = 2.5V$		-50	-92	-180	-50	-180	mA
I _{CCH}		$V_{CC} = 5.5V$; Outputs High, $V_I = G$	SND or V _{CC}		0.30	0.70		0.70	mA
I _{CCL}	Quiescent supply current	$V_{CC} = 5.5V$; Outputs Low, $V_I = G$	ND or V _{CC}		10	19		19	mA
I _{CCZ}		V_{CC} = 5.5V; Outputs 3-State; V_{I} = GND or V_{CC}		0.30	0.70		0.70	mA	
	Outputs enabled, one data input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V				400	700		700	μА
ΔI_{CC}	Additional supply current per input pin ²	Outputs disabled, one data input other inputs at V _{CC} or GND; V _{CC}			100	250		250	μА
	bar bu	Control pins, outputs disabled, or input at 3.4V, other inputs at V _{CC} V _{CC} = 5.5V		400	700		700	μΑ	

NOTES:

- Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
 This is the increase in supply current for each input at 3.4V.
 This is the bus hold overdrive current required to force the input to the opposite logic state.

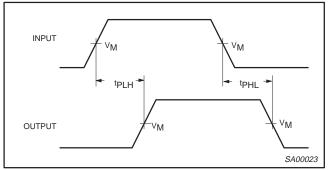
AC CHARACTERISTICS

GND = 0V; t_R = t_F = 2.5ns; C_L = 50pF, R_L = 500 Ω

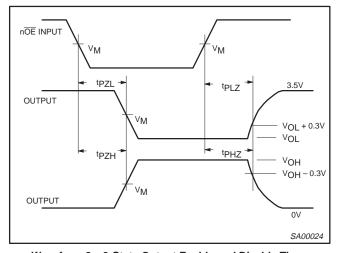
					LIMIT	rs		
SYMBOL	PARAMETER	WAVEFORM	T _a	_{imb} = +25° 'CC = +5.0'	C V	T _{amb} = -40° V _{CC} = +5	°C to +85°C .0V ±0.5V	UNIT
			Min	Тур	Max	Min	Max	
t _{PLH} t _{PHL}	Propagation delay nAx to nBx or nBx to nAx	1	1.0 1.0	2.0 2.3	3.2 3.5	1.0 1.0	3.5 4.0	ns
t _{PZH}	Output enable time to High and Low level	2	1.0 1.7	3.1 4.0	4.4 5.2	1.0 1.7	5.1 6.1	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low level	2	1.7 1.5	3.5 3.2	4.9 4.4	1.7 1.5	5.4 5.0	ns

AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to 3.0V



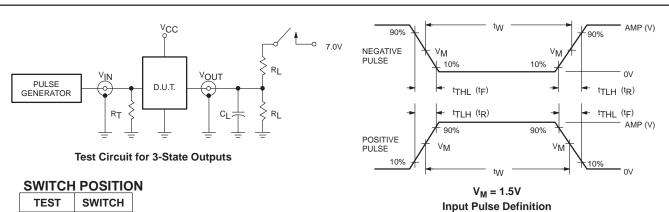
Waveform 1. Input to Output Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

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TEST CIRCUIT



TEST	SWITCH
t _{PLZ}	closed
t _{PZL}	closed
All other	open

DEFINITIONS

 R_L = Load resistor; see AC CHARACTERISTICS for value.

 C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

 $\label{eq:RT} \begin{aligned} R_T = & & \text{Termination resistance should be equal to } Z_{OUT} \text{ of } \\ & & \text{pulse generators.} \end{aligned}$

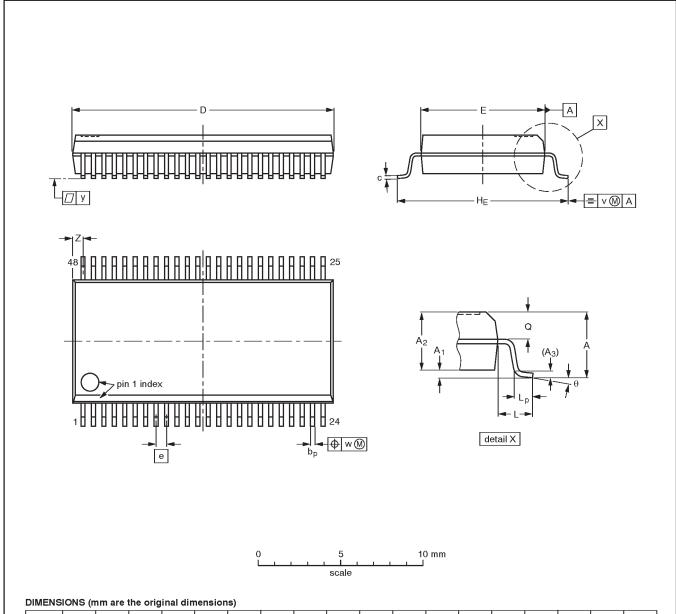
FAMILY 74ART/H16	INPUT PULSE REQUIREMENTS									
FAMILI	Amplitude	Rep. Rate	t _W	t _R	t _F					
74ABT/H16	3.0V	1MHz	500ns	2.5ns	2.5ns					

SA00018

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SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



UNI	Γ A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	16.00 15.75	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

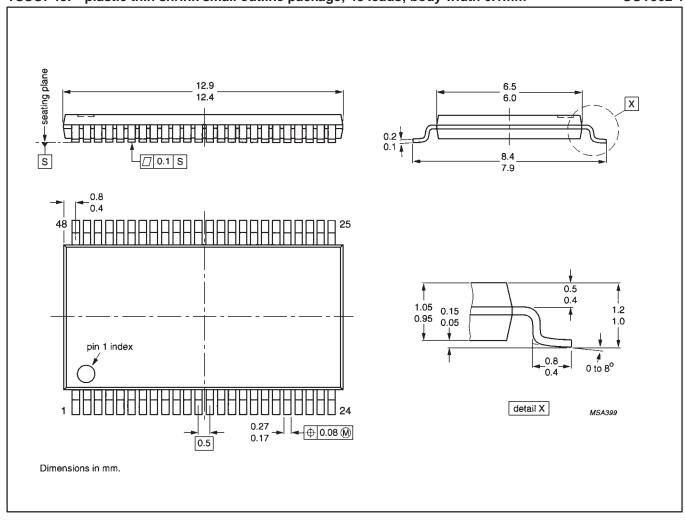
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT370-1		MO-118AA				93-11-02 95-02-04

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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



Philips Semiconductors Product specification

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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